Applicabl	e standard							
Operating temperature rai		00 0 10 100 0(11010 1)		Stora	ige erature range	-10°C to +60°C(Note 3)		
Rating	Operating humidity range		20 % to 80 % (Note 2)			40 % to 70 %(Note 3)		
	Voltage		150 V AC (DC)	Current		1 A		
	Applicable Connector		DF13-*DS-1.25C	Appli Conta	cable act	DF13(G)-2630SCF DF13-3032SCF		
	•		Specifica	tions	<u> </u>			
lt	Item		Test method			Requirements		
Construc	tion	1					1	
General exa	General examination		Visually and by measuring instrument.			According to drawing.		
Marking		Confirmed visually.						X
Electric o	haracteris	tics	·				Χ	1
Contact resis		100 m A (DC or 1000 Hz).			30 mΩ MAX.			I —
Insulation res	Insulation resistance		100 V DC.			500 MΩ MIN.		
Voltage proo	Voltage proof		for 1 min.		No flashover or breakdown.			_
Mechani	cal charact	eristics					1	
Mechanical operation		30 times insertions and extractions.			 Contact resistance: 30 mΩ MAX. No damage, crack or looseness of parts. 			_
Vibration		Frequency 10 to 55 Hz, single amplitude 0.75 mm, at 2 h, for 3 directions.			 No electrical discontinuity of 1μs. No damage, crack or looseness of parts. 			_
Shock		490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.						_
Environm	nental char	acterist	ics				1	
Rapid change of		Temperature -55→ 15 to 35→+85→ 15 to 35 °c			① Contact resistance: 30mΩ MAX.			
temperature	temperature		Time $30 \rightarrow 2 \text{ to } 3 \rightarrow 30 \rightarrow 2 \text{ to } 3 \text{ min.}$			② Insulation resistance: 500 MΩ MIN. ③ No damage, crack or looseness of parts.		
Damp heat			Under 5 cycles. Exposed at 40 ± 2 °c, 90 to 95 %, 96 h.					
(Steady state	e)	Exposed	at 40 ± 2 °C, 90 to 95 %, 96 n.				Х	_
Resistance to	o soldering	1) Reflow soldering			No deformation of case of excessive looseness			
heat		≪ Reflow area ≫ 250°C MAX 10 sec MAX 230°C MIN 60 sec MAX ≪ Preheating area ≫			of the terminals.		X	_
		170°0 Put t leave	to 190°C 60 sec to 120 sec brough in reflow furnace twice, in ambient temperature and dity for 1 hour.					
		2) Manua Solderi Solderi	I soldering ng iron temperature :300℃, ng time : 3sec. ngth on contact.					
Solderability		Soldered	at solder temperature,		Solder shall cover a minimum of			
		245°c for insertion duration, 3sec.			95 % of the surface being immersed.			

- Note 1: Include the temperature rising by current.

 Note 2: No condensing

 Note 3: Apply to the condition of long term storage for unused products before mounted on PCB.

 After mounted on PCB board, operating temperature and humidity range is applied for interim storage during transportation.

Cou	nt Description of revisions	Designed			Checked	Date		
Δ								
Unless otherwise specified, refer to IEC 60512.				Approved		HS. OKAWA	18. 02. 16	
				Ch	ecked	TS. FUKUSHIMA	18. 02. 16	
				Designed		TS. KUMAZAWA	18. 02. 16	
				D	rawn	MK. INOUE	18. 02. 16	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			Drawing no.		ng no.	ELC-367982-75-00		
HS	Specification sheet		Part no.		D	DF13EA-*DP-1. 25V (75)		
1.0	Hirose electric co., ltd.			ode no.		CL536	<u></u> <u> 1/1</u>	